APPLICABLE STANDARD

RATING	OPERATING TEMPERATURE RANGE OPERATING HUMIDITY RANGE VOLTAGE CURRENT		-30°C TO +85°C(NO	TO +85°C (NOTE 1) TEMP			PRAGE IPERATURE RANGE PRAGE IIDITY RANGE		-10°C TO +60°C(NOTE 3) 40% TO 70%(NOTE 3)		
			250V AC		APPL	LICABLE INECTOR		HNC2−2. 5S− *			
			3 A								
			SPEC	IFIC/	10TA	VS					
רו	ГЕМ	TEST METHOD					REQUIREMENTS				
CONSTR	RUCTION				•						
GENERAL EX	AMINATION	VISUALLY AND BY MEASURING INSTRUMENT.				ACCORDING TO DRAWING.					Х
MARKING		CONFIRMED VISUALLY.									X
	IC CHARA										
CONTACT RESISTANCE		1 A (DC OR 1000 Hz). 10 mΩ MAX.							X	_	
INSULATION RESISTANCE		500 V DC.			1000 ΜΩ ΜΙΝ.				Х	_	
VOLTAGE PROOF		1000 V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.				Х	_
MECHAN	VICAL CHA	RACTI	ERISTICS								
MECHANIC.		30 TIMES INSERTIONS AND EXTRACTIONS.				 CONTACT RESISTANCE: 30mΩ MAX. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				Х	_
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.				① NO ELECTRICAL DISCONTINUITY OF 10μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				Х	_
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.					ELECTRICAL DISCONTINUITY OF 10µs. DAMAGE, CRACK OR LOOSENESS OF PARTS.				_
ENVIRO	NMENTAL	CHAR	ACTERISTICS								
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 \rightarrow 5 TO 35 \rightarrow +85 \rightarrow 5 TO 35 °C TIME 30 \rightarrow 5 MAX \rightarrow 30 \rightarrow 5 MAX min UNDER 5 CYCLES.				① CONTACT RESISTANCE: 10mΩ MAX. ② INSULATION RESISTANCE: 1000MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				Х	_
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.				① CONTACT RESISTANCE: 10mΩ MAX. ② INSULATION RESISTANCE: 1000MΩ MIN.				Х	_
CORROSION SALT MIST		EXPOSED IN 5 % SALT WATER SPRAY FOR				NO DAMAGE, CRACK OR LOOSENESS OF PARTS. CONTACT RESISTANCE: 50mΩ MAX. NO HEAVY CORROSION.					_
RESISTANCE TO SOLDERING HEAT		1) AUTOMATIC SOLDERING (FLOW) SOLDER TEMPERATURE, 250 °C FOR IMMERSION, DURATION, 5 sec. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :300°C, SOLDERING TIME : 2sec. NO STRENGTH ON CONTACT.			NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.				×	_	
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE, 235 °C FOR INSERTION DURATION, 3sec.					OLDER SHALL COVER A MINIMUM OF 5 % OF THE SURFACE BEING IMMERSED.				_
NOTE2:NO C NOTE3:APPL OPEI	CONDENSING. LY TO THE CON RATING TEMPE	MPERATU	F LONG TERM STORAGE FOR THE STORAGE FOR THE STORAGE FOR THE STORAGE IS AFT TO THE STORAGE IS AT TH	OR UNUS	ED PROD	DUCTS B	EFORE PC	B ON BOAI	RD AFTER PCB BO	X	<u>,</u>
COUN	IT DE	DESCRIPTION OF REVISIONS DESIG			SNED CHECKED				DA ⁻	ΤE	
Δ											
							APPROVE	D	TY.OMA	05.10	0.07
							CHECKE	-	K.UMEHARA	05.10	
						_	DESIGNE	_	S.HIROSE	05.10	
Note QT:Q	ualification Too	t ΔΤ·Λα-	uranaa Taat V:Arriisahla Ta-t			DRAWN RAWING NO.		+			0.05
					PART		HNC2-2, 5P-*DS (55)				
HS.	SI	'ECIFI	PECIFICATION SHEET PA			INU.	TIIVUZ=Z, ƏF=₹Uð (ƏƏ)				
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HIROSE ELECTRIC CO., LTD.